CENTRAL FAX CENTER

B(M)

67,200-409; TSMC 00-661 Serial Number 09/978,420

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

TO:

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

FROM:

Tung & Associates

838 West Long Lake Road - Suite 120

Bloomfield Hills, MI 48302

DATE:

28 August 2003

REF:

Applicant: Serial No: Chou et al

09/978,420

Art Unit :

Title

2815

Filing Date

12485404035

Att'y No.

Examiner

67,200-409 N Drew Richards

15 October 2001

Microelectronic Fabrication With Upper Lying Aluminum

Fuse Layer in Copper Interconnect Semiconductor Technology

and Method for Fabrication Thereof

AMENDMENT AND RESPONSE TO OFFICE ACTION MADE FINAL

Sir:

In response to an office action mailed on 30 July 2003 and made FINAL, please consider the following amendments and remarks pertaining to the above referenced application.

There are no amendments to the specification or the drawings. Amendments to the claims are found within the Listing of the Claims that begins on page 2 of this paper. Remarks begin on page 4 of this paper.

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to the United States Patent and Trademark Office at facsimile number 703,872-9319, on Sept. 26 2003.

F-194





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OFFICIAL

Date:

Sept. 26, 2003

TO:

Examiner N. Drew Richards

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Art Unit: 2815

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Subject Matter:

09/978,420

Attorney Doc: 67,200-409

Message:

Total number of pages sent: - 8 - (including this cover sheet)